Notification Number: 20220630004.0 Notification Date: July 05, 2022								
Title: Datasheet for OPAx863								
Customer Contact: <u>PCN Manager</u>			De	ept:	Quality Services			
Change Type:								
Assembly Site		esign		Wafe	r Bump Site			
Assembly Process		ata Sheet		Wafe	r Bump Material			
		art number change		Wafer Bump Process				
Mechanical Specification					Wafer Fab Site			
Packing/Shipping/Labeling Test Proce		est Process			Wafer Fab Materials			
				Wafe	r Fab Process			
Notification Details								
Description of Change: Texas Instruments Incorporated is announcing an information only notification.								
The product datasheet(s) is The following change histor					A863, OPA2863, OPA4863			
			SB	OS982G – J	UNE 2020 - REVISED JULY 2022			
Changes from Revision F (A Added OPAx863A informati					Page			
 Added the DBV package, 5 Changed the status of the D Updated the <i>Output Voltage</i> device performance	D Package, from e vs Load Currer	preview to: production t and Output Voltage v	s Load Curi	rent figur	es to show typical			
The datasheet number will	be changing.							
Device Family		Change From		Chang	je To:			
OPAx863		SBOS982F		SBOS	982G			
These changes may be revi https://www.ti.com/produc Error! Bookmark not def Reason for Change:	<u>t/OPA863</u>	latasheet links prov	vided.					
To accurately reflect device characteristics.								
Anticipated impact on Fit, Form, Function, Quality or Reliability (positive / negative):								
No anticipated impact. This to the actual device.	is a specifica	tion change annour	ncement o	only. Th				
Changes to product identification resulting from this notification:								
None.								
		Product Affected:						
Product Affected:								
	PA863SIDBVR							

For questions regarding this notice, e-mails can be sent to the contact shown below or your local Field Sales Representative.

Location	E-Mail
WW PCN Team	PCN ww admin team@list.ti.com

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